## N－Channel 60 V（D－S）MOSFET

| PRODUCT SUMMARY |  |  |
| :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{D S}}(\mathbf{V})$ | $\mathbf{R}_{\mathbf{D S}(\text { on })}(\Omega)$ | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})^{\mathbf{a}}$ |
| 60 | 0.010 at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 15 |
|  | 0.013 at $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 12 |

## FEATURES

－ $175{ }^{\circ} \mathrm{C}$ Junction Temperature
－TrenchFET ${ }^{\circledR}$ Power MOSFET
－Material categorization：



N－Channel MOSFET


## THERMAL RESISTANCE RATINGS



## Notes：

a．Package limited．
b．Surface mounted on $1^{\prime \prime} \times 1^{\prime \prime}$ FR4 board．
c． $\mathrm{t} \leq 10 \mathrm{~s}$ ．

SPECIFICATIONS $\left(T_{J}=25^{\circ} \mathrm{C}\right.$ ，unless otherwise noted）

| Parameter | Symbol | Test Conditions | Min． | Typ．${ }^{\text {a }}$ | Max． | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Static |  |  |  |  |  |  |
| Drain－Source Breakdown Voltage | $\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 60 |  |  | V |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 1 | 2 | 3 |  |
| Gate－Body Leakage | $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  |  | $\pm 100$ | nA |
| Zero Gate Voltage Drain Current | $\mathrm{I}_{\text {DSS }}$ | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  |  | 50 |  |
|  |  | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ |  |  | 250 |  |
| On－State Drain Current ${ }^{\text {b }}$ | $\mathrm{I}_{\mathrm{D} \text {（on）}}$ | $\mathrm{V}_{\mathrm{DS}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 60 |  |  | A |
| Drain－Source On－State Resistance ${ }^{\text {b }}$ | $\mathrm{R}_{\text {DS（on）}}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ |  | 0.010 |  | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}$ |  | 0.016 |  |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ |  | 0.020 |  |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=15 \mathrm{~A}$ |  | 0.013 |  |  |
| Forward Transconductance ${ }^{\text {b }}$ | $\mathrm{g}_{\mathrm{fs}}$ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ |  | 60 |  | S |
| Dynamic |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 2650 |  | pF |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ |  |  | 470 |  |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ |  |  | 225 |  |  |
| Total Gate Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{g}}$ | $\mathrm{V}_{\mathrm{DS}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~A}$ |  | 47 | 70 | nC |
| Gate－Source Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gs}}$ |  |  | 10 |  |  |
| Gate－Drain Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gd}}$ |  |  | 12 |  |  |
| Turn－On Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d} \text {（on）}}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=30 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=0.6 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 50 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=2.5 \Omega \end{gathered}$ |  | 10 | 20 | ns |
| Rise Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{r}}$ |  |  | 15 | 25 |  |
| Turn－Off Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d} \text {（off）}}$ |  |  | 35 | 50 |  |
| Fall Time ${ }^{\text {c }}$ | $t_{f}$ |  |  | 20 | 30 |  |
| Source－Drain Diode Ratings and Characteristics（ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ ） |  |  |  |  |  |  |
| Pulsed Current | $\mathrm{I}_{\text {SM }}$ |  |  |  | 60 | A |
| Diode Forward Voltage | $\mathrm{V}_{\text {SD }}$ | $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 1 | 1.5 | V |
| Reverse Recovery Time | $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 45 | 100 | ns |

Notes：
a．For design aid only；not subject to production testing．
b．Pulse test；pulse width $\leq 300 \mu \mathrm{~s}$ ，duty cycle $\leq 2 \%$ ．
c．Independent of operating temperature．
Stresses beyond those listed under＂Absolute Maximum Ratings＂may cause permanent damage to the device．These are stress ratings only，and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied．Exposure to absolute maximum rating conditions for extended periods may affect device reliability．

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$ unless noted）



Transconductance


Capacitance


Transfer Characteristics


On－Resistance vs．Drain Current


Gate Charge

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$ unless noted）


On－Resistance vs．Junction Temperature


## THERMAL RATINGS



Maximum Drain Current vs．Ambient Temperature



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